

November 2014

# ISL9R460PF2 4 A, 600 V, STEALTH<sup>™</sup> Diode

#### **Features**

- Stealth Recovery  $t_{rr}$  = 17 ns (@  $I_F$  = 4 A)
- Max Forward Voltage, V<sub>F</sub> = 2.4 V (@ T<sub>C</sub> = 25°C)
- 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

## **Applications**

- SMPS
- · Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

### **Description**

The ISL9R460PF2 is a STEALTH™ diode optimized for low loss performance in high frequency hard switched applications. The STEALTH™ family exhibits low reverse recovery current (I<sub>rr</sub>) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I<sub>rr</sub> and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH™ diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

Package Symbol







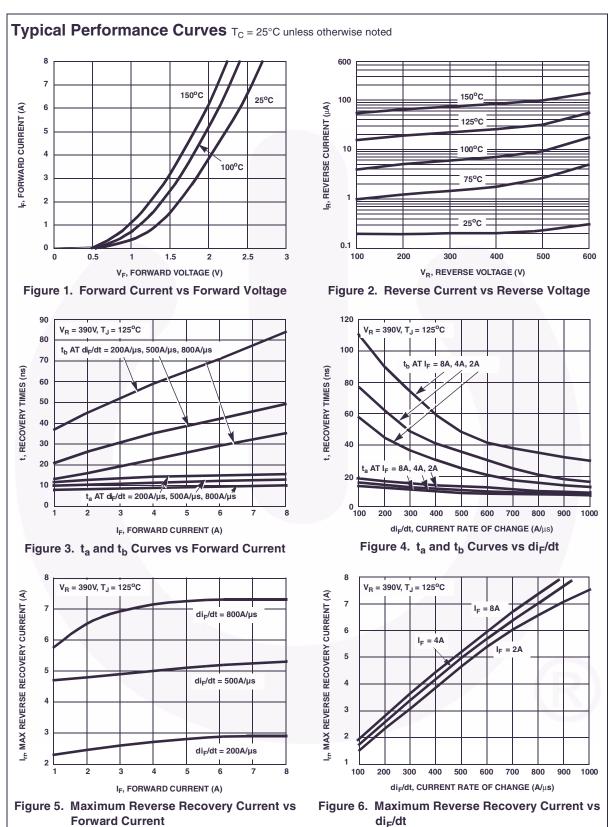


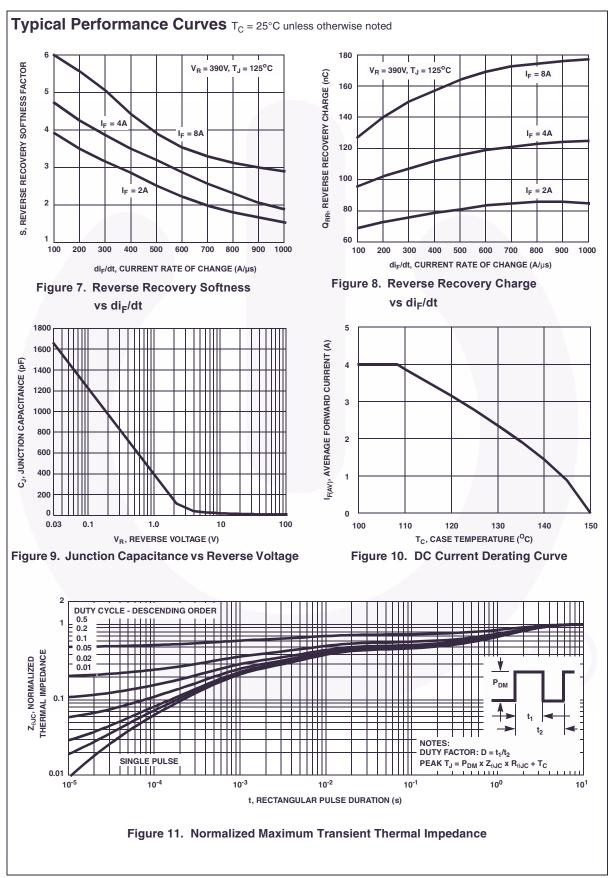
# **Device Maximum Ratings** T<sub>C</sub>= 25°C unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V
V <sub>R</sub>	DC Blocking Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (T <sub>C</sub> = 108°C)	4	А
I <sub>FRM</sub>	Repetitive Peak Surge Current (20kHz Square Wave)	8	Α
I <sub>FSM</sub>	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	50	Α
P <sub>D</sub>	Power Dissipation	22	W
E <sub>AVL</sub>	Avalanche Energy (0.5 A, 80 mH)	10	mJ
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 175	°C
T <sub>L</sub>	Maximum Temperature for Soldering	300	°C
$T_{PKG}$	Leads at 0.063in (1.6mm) from Case for 10s	260	°C
	Package Body for 10s, See Techbrief TB334		

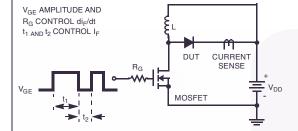
CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Package Marking and Ordering Information										
Part Number		Top Mark	Package P	Packing Method	Reel Size	Tape Width		Qı	Quantity	
ISL9R460PF2		ISL9R460PF2	TO-220F-2L	Tube	N/A	N/A			50	
Electric	al C	Characteris	stics T <sub>C</sub> = 25°C	unless otherwise note	d					
Symbol				Test Conditions		Min	Тур	Max	Unit	
Off State	Cha	racteristics				•	•		-	
	Insta	intaneous Revers	se Current	V <sub>R</sub> = 600 V	T <sub>C</sub> = 25°C	-	-	100	μА	
					T <sub>C</sub> = 125°C	-	-	1.0	mA	
On State	Cha	racteristics								
		intaneous Forwa	rd Voltage	I <sub>F</sub> = 4 A	T <sub>C</sub> = 25°C	Τ -	2.0	2.4	V	
	IIISta	intancous i orwa	ra voltage	I'F - 4 A	$T_{\rm C} = 25^{\circ}{\rm C}$	+-	1.6	2.0	V	
		racteristics		N 40 V I 0 A		-	10		T	
CJ	Junc	tion Capacitance	)	V <sub>R</sub> = 10 V, I <sub>F</sub> = 0 A		-	19	-	pF	
Switchin	g Ch	naracteristics	5							
t <sub>rr</sub>	Reve	Reverse Recovery Time		$I_F = 1 \text{ A, } di_F/dt = 100$	) A/μs, V <sub>R</sub> = 30 V	' -	17	20	ns	
			$I_F = 4 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$			19	22	ns		
t <sub>rr</sub>	Reve	Reverse Recovery Time		$I_F = 4 \text{ A},$ $di_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V}, T_C = 25^{\circ}\text{C}$		-	17	-	ns	
I <sub>rr</sub>	Reve	Reverse Recovery Current				-	2.6	-	Α	
Q <sub>rr</sub>	Reve	Reverse Recovered Charge				-	22	-	nC	
t <sub>rr</sub>	Reve	Reverse Recovery Time		$I_F = 4 \text{ A},$ $di_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V},$ $T_{-} = 135^{\circ}\text{C}$		-	77	-	ns	
S	Softr	Softness Factor (t <sub>b</sub> /t <sub>a</sub> )				-	4.2	-		
I <sub>rr</sub>	Reve	Reverse Recovery Current				-	2.8	-	Α	
Q <sub>rr</sub>	Reve	erse Recovered (	Charge	$T_C = 125^{\circ}C$		-	100	-	nC	
t <sub>rr</sub>	Reve	erse Recovery Ti	me	I <sub>F</sub> = 4 A,		-	54	-	ns	
S	Softr	Reverse Recovery Current V <sub>R</sub> = 390		$di_F/dt = 400 A/\mu s$ ,			3.5	-		
I <sub>rr</sub>	Reve			V <sub>R</sub> = 390 V,		-	4.3	-	Α	
Q <sub>rr</sub>	Reve	erse Recovered (	Charge	$T_{\rm C} = 125^{\circ}{\rm C}$			110	-	nC	
dI <sub>M</sub> /dt	Maxi	imum di/dt during	j t <sub>b</sub>			-	500	-	A/µs	
Thermal	Cha	racteristics								
$R_{\theta JC}$		mal Resistance	Junction to Case			-	-	5.7	°C/W	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient			nt TO-220F		-	-	70	°C/W	





# Test Circuit and Waveforms



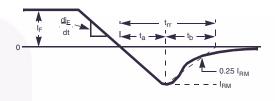
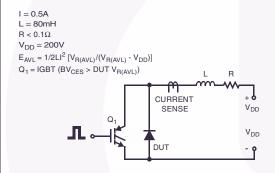


Figure 12. It<sub>rr</sub> Test Circuit

Figure 13. t<sub>rr</sub> Waveforms and Definitions



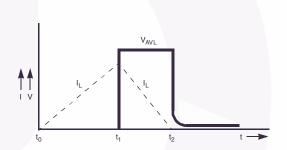


Figure 14. Avalanche Energy Test Circuit

Figure 15. Avalanche Current and Voltage Waveforms

# **Mechanical Dimensions**

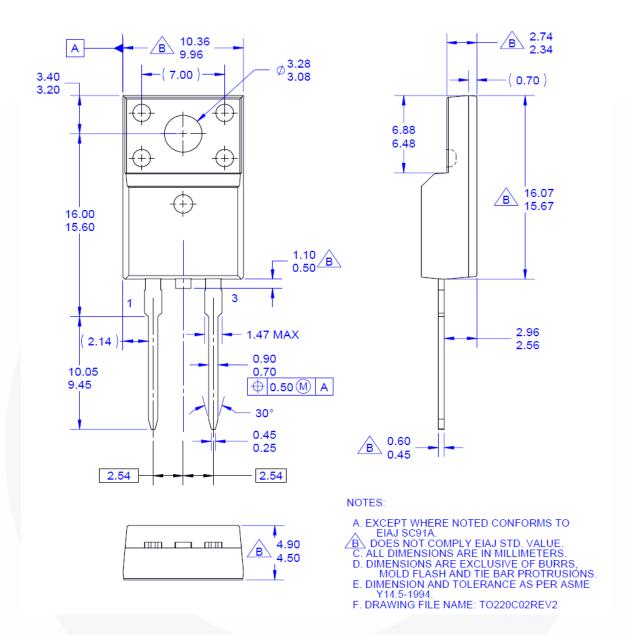


Figure 16. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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Rev. 171